

April 2013

FDH15N50 / FDP15N50 / FDB15N50 N-Channel UniFET[™] MOSFET 500 V, 15 A, 380 mΩ

Features

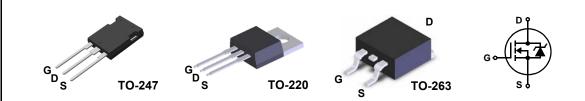
- Low gate charge Q_g results in simple drive requirement (Typ. 33 nC)
- \bullet Improved Gate, avalanche and high reapplied dv/dt
- ruggedness
- Reduced $R_{DS(on)}$ (330m Ω (Typ.) @ V_{GS} = 10 V, I_D = 7.5 A)
- Reduced Miller capacitance and low Input capacitance (Typ. C_{rss} = 16 pF)
- Improved switching speed with low EMI
- 175°C rated junction temperature

Applications

- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply

Description

UniFETTM MOSFET is Fairchild Semiconductor[®]'s high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.



Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Unit
V _{DSS}	Drain to Source Voltage	500	V
V _{GS}	Gate to Source Voltage	±30	V
۱ _D	Drain Current		
	Continuous (T _C = 25 ^o C, V _{GS} = 10V)	15	А
	Continuous (T _C = 100° C, V _{GS} = 10 V)	11	A
	Pulsed ¹	60	A
P _D	Power dissipation	300	W
	Derate above 25°C	2	W/ºC
T _J , T _{STG}	Operating and Storage Temperature	-55 to 175	°C
	Soldering Temperature for 10 seconds	300 (1.6mm from case)	°C

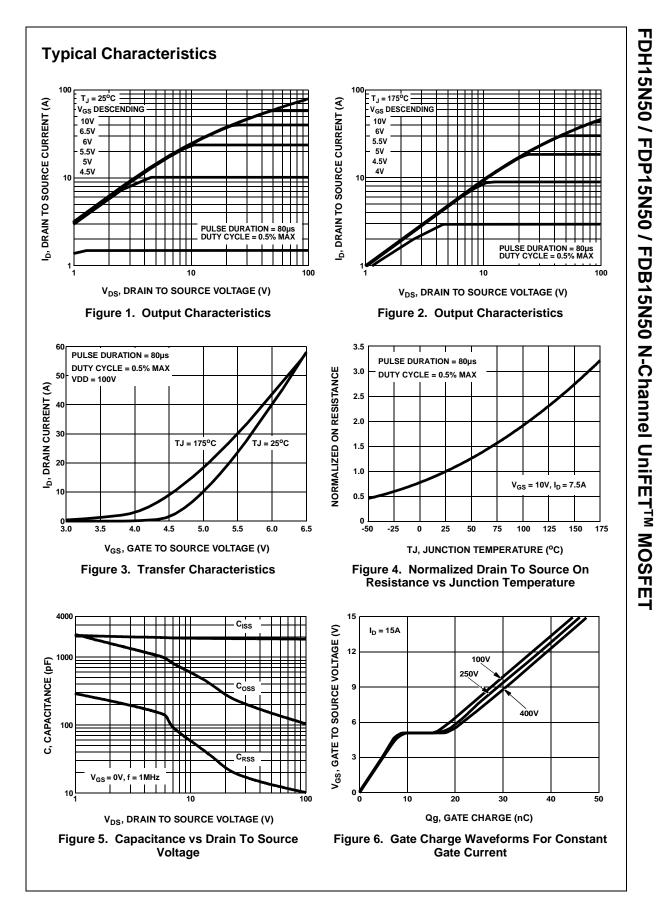
Thermal Characteristics

$R_{ extsf{ heta}JC}$	Thermal Resistance Junction to Case	0.50	°C/W
R_{\thetaJA}	Thermal Resistance Junction to Ambient (TO-247)	40	°C/W
R_{\thetaJA}	Thermal Resistance Junction to Ambient (TO-220, TO-263)	62	°C/W

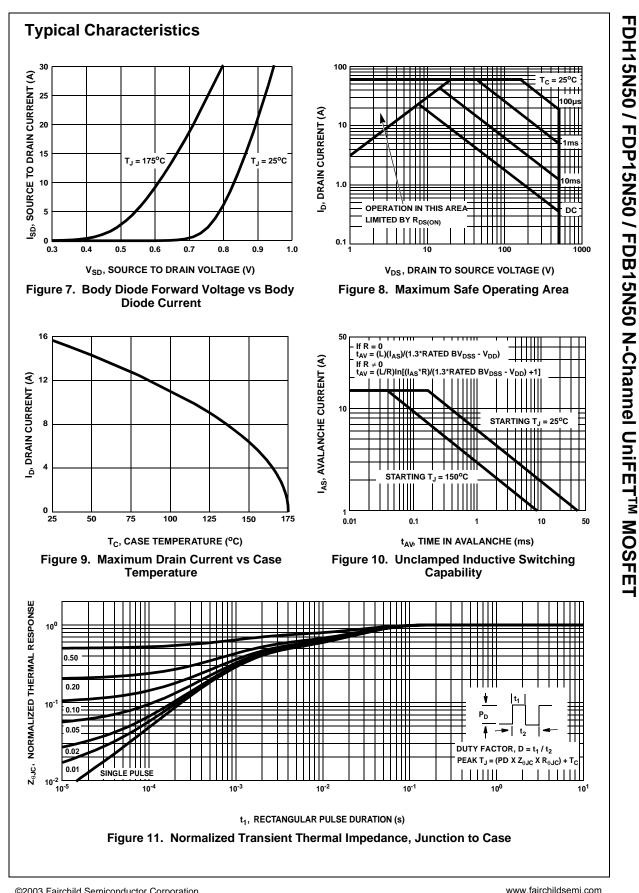
Device M	arking	Device	Package	Reel Size	Таре	e Width	Qua	antity
FDH15	N50	FDH15N50	TO-247	Tube		-	:	30
FDP15N50 FDP15N50 FDB15N50 FDB15N50		FDP15N50	TO-220	Tube		-	50	
		TO-263 330mm		24mm		800		
Electrica	l Chara	acteristics T _J = 25°C (unless otherwis	se noted)				
Symbol		Parameter		onditions	Min	Тур	Max	Unit
Statics								
B _{VDSS}	Drain to S	ource Breakdown Voltage	Ι _D = 250μA,	$V_{GS} = 0V$	500	-	-	V
$\Delta B_{VDSS} / \Delta T_{J}$	Breakdow	n Voltage Temp. Coefficient	Reference I ID = 1mA	ю 25 ⁰ С,	-	0.58	-	V/°C
r _{DS(ON)}	Drain to S	ource On-Resistance	V _{GS} = 10V,	V _{GS} = 10V, I _D = 7.5A		0.33	0.38	Ω
V _{GS(th)}	Gate Thre	shold Voltage	$V_{DS} = V_{GS}$,		2.0	3.4	4.0	V
	Zero Coto	Voltage Drain Current	V _{DS} = 500V	-	-	-	25	
IDSS	Zero Gate Voltage Drain Current	$V_{GS} = 0V$	$T_{C} = 150^{\circ}C$	-	-	250	μA	
I _{GSS}	Gate to So	ource Leakage Current	$V_{GS} = \pm 30V$		-	-	±100	nA
Dynamics								
9 _{fs}	Forward T	ransconductance	V _{DD} = 10V,	_D = 7.5A	10	-	-	S
Q _{g(TOT)}	Total Gate	e Charge at 10V	$V_{GS} = 10V, V_{DS} = 400V, V_{DS} = 400V, V_{DD} = 15A$ $V_{DD} = 250V, V_{D} = 15A, R_{G} = 6.2\Omega, R_{D} = 17\Omega$ $V_{DS} = 25V, V_{GS} = 0V, F = 1MHz$		-	33	41	nC
Q _{gs}	Gate to S	ource Gate Charge			-	7.2	10	nC
Q _{gd}	Gate to D	rain "Miller" Charge			-	12	16	nC
t _{d(ON)}	Turn-On E	Delay Time			-	9	-	ns
t _r	Rise Time)			-	5.4	-	ns
t _{d(OFF)}	Turn-Off E	Delay Time			-	26	-	ns
t _f	Fall Time				-	5	-	ns
CISS	Input Cap	acitance			-	1850	-	pF
C _{OSS}	Output Ca	apacitance			-	230	-	pF
C _{RSS}	Reverse 1	ransfer Capacitance				16	-	pF
Avalanche	Charac	teristics						
E _{AS}	Single Pu	lse Avalanche Energy ²			760	-	-	mJ
I _{AR}	Avalanche	e Current			-	-	15	Α
Drain-Sou	rce Diod	le Characteristics						
۱ _S	Continuou (Body Dio	is Source Current de)	MOSFET symbol showing the integral reverse p-n junction diode.		-	-	15	А
I _{SM}	Pulsed So (Body Dio	ource Current ¹ de)			-	-	60	А
V _{SD}	Source to	Drain Diode Voltage	I _{SD} = 15A		-	0.86	1.2	V
t _{rr}	Reverse F	Recovery Time	$I_{SD} = 15A$, $di_{SD}/dt = 100A/\mu s$		-	470	730	ns
Q _{RR}	Dovoroo E	Recovered Charge	$I_{SD} = 15A, di_{SD}/dt = 100A/\mu s$		-	5	6.6	μC

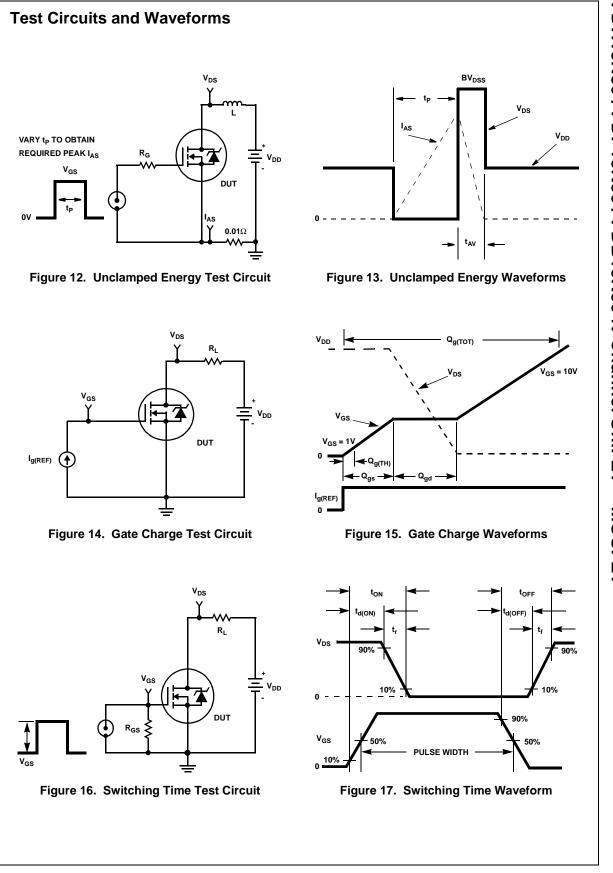
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	Formative / In Design First Production Full Production		